# **IGBT - Field Stop, Trench**

650 V, 40 A

## FGH40T65UPD

#### Description

Using innovative field stop trench IGBT technology, ON Semiconductor's new series of field-stop trench IGBTs offer optimum performance for solar inverter, UPS, welder, and digital power generator where low conduction and switching losses are essential.

#### Features

- Maximum Junction Temperature:  $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage:  $V_{CE(sat)} = 1.65 V(Typ.) @ I_C = 40 A$
- 100% of Parts Tested I<sub>LM</sub> (Note 2)
- High Input Impedance
- Tightened Parameter Distribution
- Short Circuit Ruggedness > 5 μs @ 25°C
- This Device is Pb-Free and is RoHS Compliant

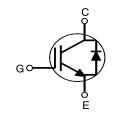
#### Applications

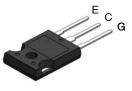
- Solar Inverter, UPS, Welder, Digital Power Generator
- Telecom, ESS



### **ON Semiconductor®**

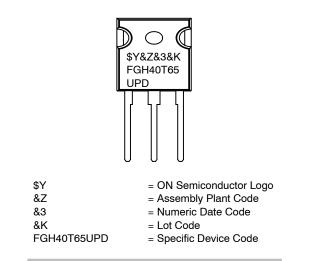
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TO-247-3LD CASE 340CK

#### MARKING DIAGRAMS



#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

#### **ABSOLUTE MAXIMUM RATINGS**

| Descriptio                                      | Symbol                           | Ratings          | Unit |    |
|---|----------------------------------|------------------|------|----|
| Collector to Emitter Voltage                    |                                  | V <sub>CES</sub> | 650  | V  |
| Gate to Emitter Voltage                         |                                  | V <sub>GES</sub> | ±20  | V  |
| Transient Gate to Emitter Voltage               | 1 f                              | ±25              | V    |    |
| Collector Current                               | $T_{\rm C} = 25^{\circ}{\rm C}$  | Ι <sub>C</sub>   | 80   | А  |
| Collector Current                               | T <sub>C</sub> = 100°C           | 1 f              | 40   | А  |
| Pulsed Collector Current (Note 1)               | •                                | I <sub>CM</sub>  | 120  | А  |
| Clamped Inductive Load Current (Note 2)         | $T_{\rm C} = 25^{\circ}{\rm C}$  | I <sub>LM</sub>  | 120  | А  |
| Diode Forward Current                           | $T_{\rm C} = 25^{\circ}{\rm C}$  | ١ <sub>F</sub>   | 40   | А  |
| Diode Forward Current                           | $T_{\rm C} = 100^{\circ}{\rm C}$ | 1 f              | 20   | А  |
| Pulsed Diode Maximum Forward Current (No        | ote 1)                           | I <sub>FM</sub>  | 120  | А  |
| Maximum Power Dissipation $T_{C} = 25^{\circ}C$ |                                  | PD               | 268  | W  |
| Maximum Power Dissipation                       | $T_{\rm C} = 100^{\circ}{\rm C}$ | 1 f              | 134  | W  |
| Short Circuit Withstand Time                    | $T_{\rm C} = 25^{\circ}{\rm C}$  | SCWT             | 5    | μs |
| Operating Junction Temperature                  | TJ                               | –55 to +175      | °C   |    |
| Storage Temperature Range                       | T <sub>stg</sub>                 | –55 to +175      | °C   |    |
| Maximum Lead Temp. for Soldering Purpose        | ΤL                               | 300              | °C   |    |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
Repetitive rating: Pulse width limited by max. junction temperature.
Ic = 120 A, Vce = 400 V, Rg = 15 Ω

#### **THERMAL CHARACTERISTICS**

| Parameter                                    | Symbol          | Value | Unit |
|--|-----------------|-------|------|
| Thermal Resistance, Junction to Case (IGBT)  | $R_{\theta JC}$ | 0.56  | °C/W |
| Thermal Resistance, Junction to Case (Diode) | $R_{\theta JC}$ | 1.71  | °C/W |
| Thermal Resistance, Junction to Ambient      | $R_{	hetaJA}$   | 40    | °C/W |

#### PACKAGE MARKING AND ORDERING INFORMATION

| Part Number | Top Mark    | Package    | Packing Method | Reel Size | Tape Width | Quantity |
|-------------|-------------|------------|----------------|-----------|------------|----------|
| FGH40T65UPD | FGH40T65UPD | TO-247-3LD | Tube           | N/A       | N/A        | 30       |

#### ELECTRICAL CHARACTERISTICS OF THE IGBT (T<sub>C</sub> = 25°C unless otherwise noted)

| Parameter                                       | Symbol   | ol Test Conditions                               |     | Тур  | Max  | Unit |  |
|---|--|--|-----|------|------|------|--|
| DFF CHARACTERISTICS                             |  |  |     |      |      |      |  |
| Collector to Emitter Breakdown Voltage          | BV <sub>CES</sub>                                    | V <sub>GE</sub> = 0 V, I <sub>C</sub> = 1 mA     | 650 | -    | -    | V    |  |
| Temperature Coefficient of Breakdown<br>Voltage | $\Delta {\rm BV}_{\rm CES} / \Delta {\rm T}_{\rm J}$ | $V_{GE}$ = 0 V, I <sub>C</sub> = 250 µA          |     | 0.65 |      | V/°C |  |
| Collector Cut-Off Current                       | I <sub>CES</sub>                                     | $V_{CE} = V_{CES}, V_{GE} = 0 V$                 | -   | -    | 250  | μA   |  |
| G-E Leakage Current                             | I <sub>GES</sub>                                     | $V_{GE} = V_{GES}, V_{CE} = 0 V$                 | -   | -    | ±400 | nA   |  |
| ON CHARACTERISTICS                              |  |  |     |      |      |      |  |
| G-E Threshold Voltage                           | V <sub>GE(th)</sub>                                  | $I_{C}$ = 40 mA, $V_{CE}$ = $V_{GE}$             | 4.0 | 6.0  | 7.5  | V    |  |
| Collector to Emitter Saturation Voltage         | V <sub>CE(sat)</sub>                                 | I <sub>C</sub> = 40 A, V <sub>GE</sub> = 15 V    | -   | 1.65 | 2.3  | V    |  |
|   |  | $I_{C}$ = 40 A, $V_{GE}$ = 15 V, $T_{C}$ = 175°C | -   | 2.1  | -    | V    |  |

| ELECTRICAL CHARACTERISTICS OF THE IGB | $\Gamma$ (T <sub>C</sub> = 25°C unless otherwise noted) (continued) |
|---------------------------------------|---|
|---------------------------------------|---|

| Parameter                    | Symbol              | Test Conditions  | Min | Тур  | Max  | Unit |
|------------------------------|---------------------|--|-----|------|------|------|
| DYNAMIC CHARACTERISTICS      |                     | ·  |     |      |      |      |
| Input Capacitance            | C <sub>ies</sub>    | $V_{CE}$ = 30 V, $V_{GE}$ = 0 V, f = 1 MHz                                   | -   | 2730 | 3630 | pF   |
| Output Capacitance           | C <sub>oes</sub>    | 1  | -   | 82   | 110  | pF   |
| Reverse Transfer Capacitance | C <sub>res</sub>    | 1  | -   | 48   | 72   | pF   |
| SWITCHING CHARACTERISTICS    |                     |  |     |      |      |      |
| Turn-On Delay Time           | t <sub>d(on)</sub>  | $V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A},$                      | -   | 20   | 26   | ns   |
| Rise Time                    | t <sub>r</sub>      | $R_G = 7 \Omega$ , $V_{GE} = 15 V$ ,<br>Inductive Load, $T_C = 25^{\circ}C$  | -   | 26   | 34   | ns   |
| Turn-Off Delay Time          | t <sub>d(off)</sub> | 1  | -   | 144  | 187  | ns   |
| Fall Time                    | t <sub>f</sub>      | 1  | -   | 17   | 22   | ns   |
| Turn-On Switching Loss       | E <sub>on</sub>     | 1  | -   | 1.59 | 2.1  | mJ   |
| Turn-Off Switching Loss      | E <sub>off</sub>    | 1  | -   | 0.58 | 0.76 | mJ   |
| Total Switching Loss         | E <sub>ts</sub>     | 1  | -   | 2.17 | 2.86 | mJ   |
| Turn-On Delay Time           | t <sub>d(on)</sub>  | $V_{\rm CC} = 400 \text{ V}, \text{ I}_{\rm C} = 40 \text{ A},$              | -   | 19   | -    | ns   |
| Rise Time                    | t <sub>r</sub>      | $R_G = 7 \Omega$ , $V_{GE} = 15 V$ ,<br>Inductive Load, $T_C = 175^{\circ}C$ | -   | 38   | -    | ns   |
| Turn-Off Delay Time          | t <sub>d(off)</sub> | 1  | -   | 153  | -    | ns   |
| Fall Time                    | t <sub>f</sub>      | 1  | -   | 60   | -    | ns   |
| Turn-On Switching Loss       | E <sub>on</sub>     | 1  | -   | 1.84 | -    | mJ   |
| Turn–Off Switching Loss      | E <sub>off</sub>    | 1  | -   | 0.98 | -    | mJ   |
| Total Switching Loss         | E <sub>ts</sub>     | 1  | -   | 2.82 | -    | mJ   |
| Short Circuit Withstand Time | Tsc                 | $V_{GE}$ = 15 V, $V_{CC}$ $\leq$ 400 V, Rg = 10 $\Omega$                     | 5   | -    | -    | μs   |
| Total Gate Charge            | Qg                  | $V_{CE}$ = 400 V, I <sub>C</sub> = 40 A, V <sub>GE</sub> = 15 V              | -   | 177  | 265  | nC   |
| Gate to Emitter Charge       | Q <sub>ge</sub>     | 1  | -   | 23   | 35   | nC   |
| Gate to Collector Charge     | Q <sub>gc</sub>     | 1  | -   | 100  | 150  | nC   |

### **ELECTRICAL CHARACTERISTICS OF THE DIODE** (T<sub>C</sub> = $25^{\circ}$ C unless otherwise noted)

| Parameter                     | Symbol           | Test Conditions  |                        | Min | Тур | Max | Unit |
|-------------------------------|------------------|--|------------------------|-----|-----|-----|------|
| Diode Forward Voltage         | V <sub>FM</sub>  | I <sub>F</sub> = 20 A                                    | $T_{C} = 25^{\circ}C$  | -   | 2.1 | 2.7 | V    |
|                               |                  |  | T <sub>C</sub> = 175°C | -   | 1.9 | -   |      |
| Reverse Recovery Energy       | E <sub>rec</sub> | I <sub>F</sub> = 20 A,<br>di <sub>F</sub> /dt = 200 A/μs | T <sub>C</sub> = 175°C | -   | 96  | -   | μJ   |
| Diode Reverse Recovery Time   | t <sub>rr</sub>  |  | $T_{C} = 25^{\circ}C$  | -   | 33  | 43  | ns   |
|                               |                  |  | T <sub>C</sub> = 175°C | -   | 128 | -   | 1    |
| Diode Reverse Recovery Charge | Q <sub>rr</sub>  |  | $T_{C} = 25^{\circ}C$  | -   | 53  | 74  | nC   |
|                               |                  |  | T <sub>C</sub> = 175°C | -   | 341 | -   | 1    |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### **TYPICAL PERFORMANCE CHARACTERISTICS**

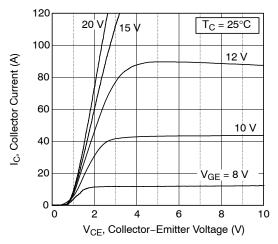


Figure 1. Typical Output Characteristics

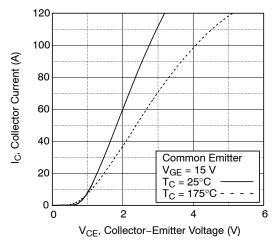


Figure 3. Typical Saturation Voltage Characteristics

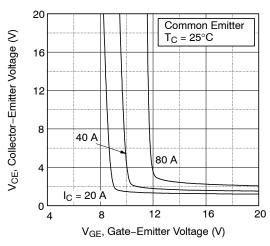


Figure 5. Saturation Voltage vs. V<sub>GE</sub>

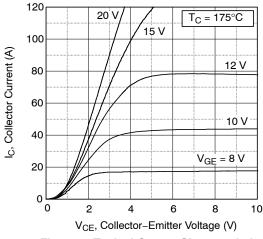


Figure 2. Typical Output Characteristics

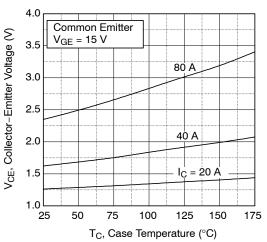
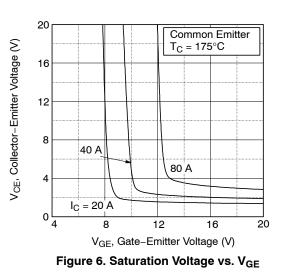


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level



#### TYPICAL PERFORMANCE CHARACTERISTICS (continued)

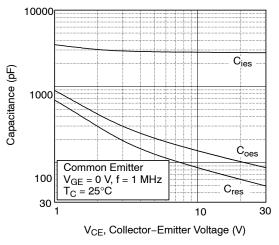


Figure 7. Capacitance Characteristics

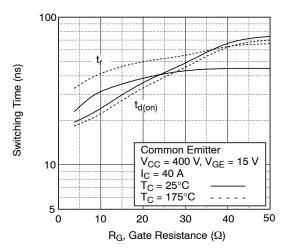


Figure 9. Turn-On Characteristics vs. Gate Resistance

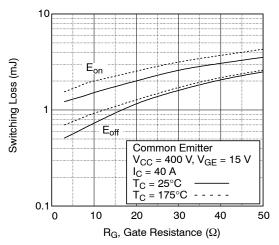


Figure 11. Switching Loss vs. Gate Resistance

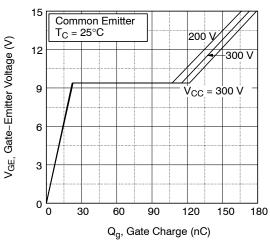


Figure 8. Gate Charge Characteristics

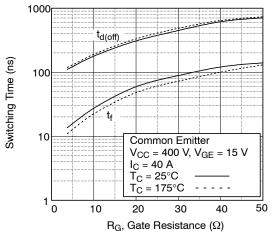


Figure 10. Turn-Off Characteristics vs. Gate Resistance

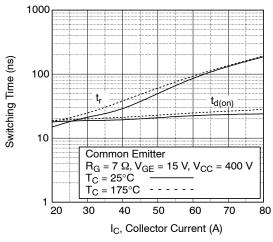
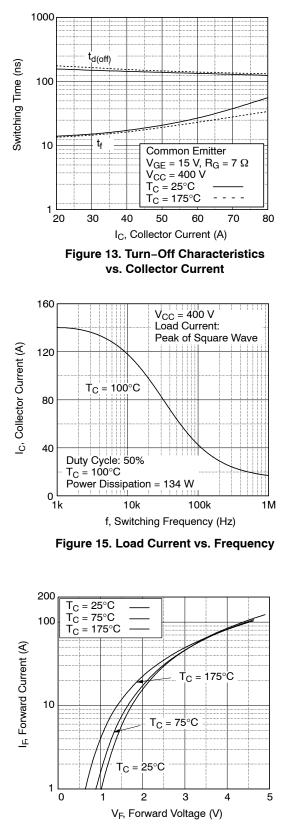


Figure 12. Turn-On Characteristics vs. Collector Current

#### TYPICAL PERFORMANCE CHARACTERISTICS (continued)



**Figure 17. Forward Characteristics** 

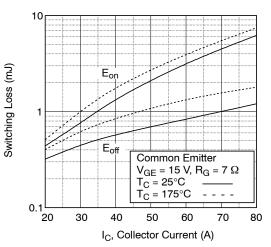


Figure 14. Switching Loss vs. Collector Current

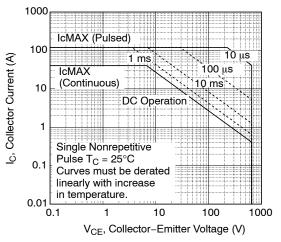
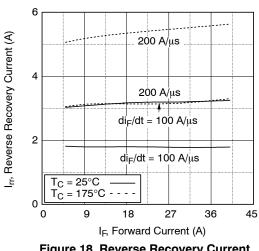


Figure 16. SOA Characteristics





#### TYPICAL PERFORMANCE CHARACTERISTICS (continued)

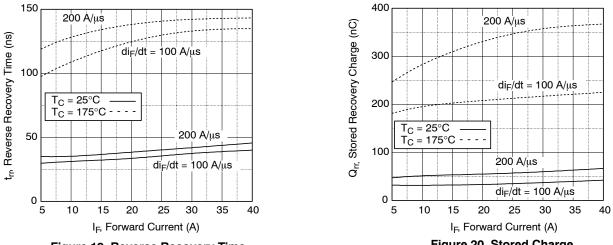


Figure 19. Reverse Recovery Time



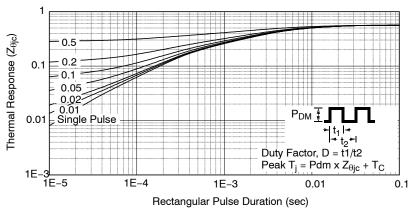


Figure 21. Transient Thermal Impedance of IGBT

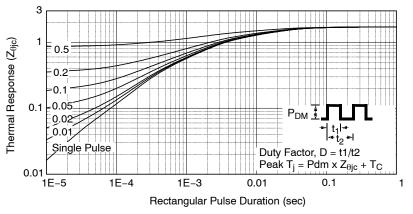


Figure 22. Transient Thermal Impedance of Diode





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